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Effect of surface passivation process for AlGaIn/GaN HEMT heterostructures using phenol functionalized-porphyrin based organic molecules

Manjari Garg,^{1,a)} Tejas Rajendra Naik,² Ravi Pathak,¹ Valipe Ramgopal Rao,³ Che-Hao Liao,⁴ Kuang-Hui Li,⁴ Haiding Sun,⁴ Xiaohang Li,⁴ and Rajendra Singh¹

¹Department of Physics, Indian Institute of Technology Delhi, Hauz Khas, New Delhi 110016, India

²Centre of Excellence in Nanoelectronics, Indian Institute of Technology Bombay, Powai, Mumbai, Maharashtra 400076, India

³Department of Electrical Engineering, Indian Institute of Technology Delhi, Hauz Khas, New Delhi 110016, India

⁴Advanced Semiconductor Laboratory, King Abdullah University of Science and Technology (KAUST), Thuwal 23955-6900, Saudi Arabia

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In this work, we investigate an unexplored possibility of passivating the charged surface states on AlGaIn/GaN high electron mobility transistor (HEMT) heterostructures by using organic molecules. This has further led to remarkable enhancement in the electrical properties of rectifying metal-semiconductor contacts on AlGaIn/GaN. Phenol functionalized Zinc metallated-Tetra Phenyl Porphyrin (Zn-TPPOH) organic molecules were adsorbed on AlGaIn/GaN via the solution phase to form a molecular layer (MoL). The presence of the MoL was confirmed using X-ray Photoelectron Spectroscopy (XPS). The thickness of the MoL was assessed as ~ 1 nm, using Spectroscopic Ellipsometry and cross-sectional Transmission Electron Microscopy. XPS peak-shift analyses together with Kelvin Probe Force Microscopy revealed that the molecular surface modification reduced the surface potential of AlGaIn by approximately 250 meV. Consequently, the Barrier height (ideality factor) of Ni Schottky diodes on AlGaIn/GaN was increased (reduced) significantly from 0.91 ± 0.05 eV (2.5 ± 0.31) for Ni/AlGaIn/GaN to 1.37 ± 0.03 eV (1.4 ± 0.29) for Ni/Zn-TPPOH/AlGaIn/GaN. In addition, a noteworthy decrement in the reverse current from 2.6 ± 1.93 μ A to 0.31 ± 0.19 nA at -5 V (~ 10 000 times) was observed from Current-Voltage (I-V) measurements. This surface-modification process can be fruitful for improving the performance of AlGaIn/GaN HEMTs, mitigating the adverse effects of surface states and polarization in these materials. Published by AIP Publishing. <https://doi.org/10.1063/1.5049873>

I. INTRODUCTION

The expanding market for cellular, personal communication services, military, or space satellite systems requires radio frequency and microwave power amplifiers. One of the most promising candidates for these technologies is the high electron mobility transistor (HEMT). The potential of HEMTs is a result of its superior device properties and the 2-dimensional channel layer which allows the carriers to flow with high mobility.^{1,2} Previous studies from the literature have shown that AlGaIn/GaN semiconductor materials are ideal for the fabrication of high power, high frequency HEMTs. AlGaIn/GaN based HEMTs have been used for various applications such as satellite television receivers, voltage converters, cell phones, high voltage transistor switches, radar equipment, and high power transmitters.³⁻⁶ This is because along with superior material properties, these heterostructures are characterized by macroscopic polarization (related to high electronegativity of nitrogen) which effectively reduces the on-resistance and thus power loss.⁷ Another unique property of these materials is that no intentional doping is required to generate the two-dimensional

electron gas (2DEG) at the AlGaIn/GaN interface. It has been reported that at unintentionally doped strained AlGaIn/GaN interface, 2DEG is formed due to the polarization effect.^{8,9} It has also been reported that the presence of surface states on AlGaIn is another cause for the formation of the 2DEG.¹⁰ But, on the one hand, surface states are helpful and on the other hand they are responsible for degrading the device performance and reliability.^{11,12}

Various sources of surface states have been described, including gap states,^{13,14} defect related states,¹⁵ and disorder induced gap states (DIGS).^{16,17} A substantial density of these states along with the polarization effect^{18,19} yields a net charge on the surface of the semiconductor which has adverse effects. Firstly, the energy levels of the semiconductor start bending at the surface (either upward or downward depending on the polarity of the surface charge), before forming contact with other materials. Secondly, when the metal comes in contact with the semiconductor, an interface potential is generated at the metal-semiconductor interface leading to Fermi level pinning in the semiconductor and violation of the Schottky-Mott rule ($\phi_{Bn} = \phi_m - \chi_s$)²⁰⁻²² [where ϕ_{Bn} is the Schottky barrier height (SBH), ϕ_m is the work function of the metal, and χ_s is the electron affinity of the semiconductor]. Thirdly, the large concentration of these gap states at the metal/AlGaIn/GaN interface also allow

^{a)}Electronic mail: megaharg142@gmail.com

tunneling of carriers during reverse bias, leading to a large leakage current,¹² thereby degrading the device efficiency.

In search of strategies to overcome these issues, we came across a unique concept of modulation of the surface electrical properties of some semiconductors by the adsorption of amphiphilic organic molecules. These molecules have a specific structure consisting of three parts: the head group that binds to the substrate (the semiconductor), the tail group that is away from the substrate, and the backbone that connects them.^{23,24} Experimental and theoretical investigations have shown that such an approach reconstructs the surface (onto which the molecules have bonded) and affects the surface energy levels without actual transfer of electrons between the molecule and the substrate. When the molecules are adsorbed onto the surface of the semiconductor, they tune either the surface band-bending^{25,26} (surface potential generated due to the surface charge) of the semiconductor or the electron affinity^{27,28} or sometimes both.²⁹ The insertion of the organic molecules at the metal-semiconductor interfaces of Schottky contacts on some semiconductors has also been demonstrated to modify the SBH^{30–33} and reduce the reverse leakage current, significantly.³³ Apart from SBH modification, the application of metal/molecular layer/semiconductor structures was also seen when organic molecules of metallated Porphyrin were used as copper metal diffusion barriers for SiO₂-Si based CMOS technologies.³⁴ Not only the gate electrode, but the application of organic molecules has also been reported to modify the source and drain electrodes on graphene based field-effect transistors.³⁵

In this work, the phenomenon of adsorption of the organic molecular layer was applied to AlGaIn/GaN HEMT heterostructures to resolve the surface state related issues. The adsorption of different molecules on AlGaIn/GaN has been reported in the literature. The hybrid organic/AlGaIn/GaN interfaces have been used as solution gate field effect transistors for the electronic detection of some specific biomolecular processes.^{36,37} Here, we present, for the first time, the adsorption of phenol functionalized metallated-Tetra Phenyl Porphyrin (Zn-TPPOH) organic molecules on AlGaIn/GaN HEMT epitaxial films. The presence of the molecular layer, its bonding with the AlGaIn/GaN surface, and its thickness were studied using XPS, Spectroscopic ellipsometry, and X-TEM, respectively. XPS peak shift analysis and Kelvin Probe Force Microscopy (KPFM) revealed that the molecular surface-modification was responsible for the decrease in the surface potential of the AlGaIn layer. Furthermore, as the Schottky metal was deposited on the molecular-coated AlGaIn/GaN, a considerable increment in the SBH and a noteworthy decrement in the current during the reverse bias were observed from Current-Voltage (I-V) measurements. The working principle of metal/organic molecules/semiconductor structures has been illustrated with the help of energy band diagrams and schematic illustrations.

II. EXPERIMENTAL SECTION

A. Adsorption of the layer of organic molecules

Organic molecular layers can be adsorbed on the sample surface from either the liquid phase or the vapour phase.²³ In this work, the molecular layer (MoL) was formed using the solution phase approach where on immersion of the sample in the

molecular solution, for some optimized time, the head group of the molecular assemblies spontaneously assemble and bond with the surface atoms of the sample. This is followed by a slow organization of the backbone and the tail part of the molecular assemblies. Due to the specific structure of the molecules (head-backbone-tail assembly) and specialized molecular processing, a single layer of hydrocarbon film (which is self-terminating in nature) is chemisorbed onto the sample surface.

Unintentionally doped Al_{0.25}Ga_{0.75}N/GaN high electron mobility transistor (HEMT) epitaxial layers were grown on 2 in. diameter c-plane sapphire substrate. The growth was carried out using the Metal-Organic Vapour Phase Epitaxy (MOVPE) technique. The structure of the sample was Sapphire/AlN (nucleation layer 150 nm)/Al_{1-x}Ga_xN (transition layer 1 μm)/UID GaN (channel layer 650 nm)/Al_{0.25}Ga_{0.75}N (donor layer 25 nm), as shown in Fig. 1(a). The Hall effect measurement revealed the room temperature conduction properties of the 2DEG (channel) as Hall electron mobility (μ_e) ~1300 cm²/Vs, sheet carrier concentration (N_s) ~1.5 × 10¹³ cm⁻², and sheet resistance (R_s) ~384 Ω/sq. The AlGaIn/GaN/Sapphire wafer was diced into pieces of 1 cm × 1 cm dimension. Thereafter, the sample pieces were cleaned using de-ionized (DI) water, acetone, and isopropanol (IPA), sequentially, in an ultra-sonic bath cleaner for 5 min each at room temperature and again rinsed-off with DI-water. In the next cleaning step, the sample surface was mildly etched by dipping in an acidic solution of hydrochloric acid and water, mixed in the ratio of 1:2, for 2 min. The samples were washed with DI-water for a long time, so as to remove the etching remnants. Lastly, the samples were dried properly, using a dry nitrogen jet.

FIG. 1. (a) The structure of the Al_{0.25}Ga_{0.75}N/GaN sample. (b) Adsorption of Zn-TPPOH organic molecules on AlGaIn/GaN. (c) Chemical structure of the Zn-TPPOH organic molecule and its bonding with the sample surface. (d) Device structure fabricated on Zn-TPPOH/AlGaIn/GaN samples.

Hydroxyl-Phenyl-Zinc-Tetra-Phenyl-Porphyrin (Zn-TPPOH) organic molecules were used as the basic precursor for the MoL (preparation explained elsewhere^{35,38}). The chemical structure of this precursor is shown in Fig. 1(c). These precursor solutes were dissolved in the toluene organic solvent to form a 0.1 mM molecular solution. Following this, some of the cleaned AlGaIn/GaN samples were placed in the molecular solution for 2 h (time decided after many optimizations) at room temperature in cleaned air tight bottles (as the toluene solvent is volatile), to get a saturated coverage of the organic molecules on the sample surface, as illustrated in Fig. 1(b). Thereafter, the samples were gently cleaned using iso-propanol and rinsed-off using DI-water. The samples were dried, gently, using the dry nitrogen jet. Furthermore, to remove the moisture, the samples were placed in the hot air oven at 120 °C for 10–15 min. The Zn-TPPOH/AlGaIn/GaN samples were characterized using X-Ray Photoelectron Spectroscopy [XPS: SPECS; PHOIBOS HSA3500 150 R6 (HW Type 30:14) MCD-9], Variable Angle Spectroscopic Ellipsometry (VASE: J.A. Woollam Inc. Ellipsometry solutions), and Kelvin Probe Force Microscopy (KPFM) (Dimension Icon microscope: Bruker Corporation, Billerica, MA, USA).

B. Device fabrication

Ohmic contacts were fabricated on the four corners of the cleaned AlGaIn/GaN samples. A few Ohmic-contacted samples were dipped in the Zn-TPPOH molecular solution for 2 h and processed according to the above-mentioned steps. In the next step, Schottky contacts were patterned on both ohmic-contacted bare AlGaIn/GaN samples and Zn-TPPOH/AlGaIn/GaN in the form of circles having a diameter of 500 μm using optical lithography [Intelligent Micro Patterning Maskless Photolithography system (SF-100 Xpress)]. Subsequently, the patterned samples were loaded in the thermal evaporation chamber at a vacuum pressure of 10^{-6} Torr. The Nickel (Ni) (40 nm)/Gold (Au) (100 nm) metal stack was evaporated at a deposition rate of about 1 $\text{\AA}/\text{s}$. The metal film was finally lifted-off by dipping the samples in hot acetone (100 °C) for 5–10 min leaving Ni/Au metal Schottky contacts on the sample surface. Overall, two different device structures were devised, Ni/AlGaIn/GaN and Ni/Zn-TPPOH/AlGaIn/GaN. A schematic representation of the Schottky/MoL/AlGaIn/GaN structures is presented in Fig. 1(d). The interfaces of metal/AlGaIn/GaN and metal/MoL/AlGaIn/GaN structures were imaged using cross-sectional Transmission Electron Microscopy (X-TEM: FEI Titan ST microscope system). The current-voltage (I-V) and capacitance-voltage (C-V) characteristics of Schottky contacts on bare AlGaIn/GaN samples and MoL coated AlGaIn/GaN samples were measured using the Keithley Semiconductor Characterization System (SCS-4200).

III. RESULTS AND DISCUSSION

A. Characterization of the organic molecular layer on AlGaIn/GaN

1. X-ray photoelectron spectroscopy (XPS)

The presence of Zn-TPPOH organic molecules on AlGaIn/GaN was confirmed by X-Ray Photoelectron

Spectroscopy (XPS). XPS was also used to investigate the nature of bonds formed between the organic molecular layer (MoL) and the c-plane AlGaIn/GaN surface. XPS measurements were performed with Al K α X-ray excitation on Zn-TPPOH coated AlGaIn/GaN samples in an ultra-high vacuum ($\sim 10^{-9}$ mbar) environment at three different positions on the sample surface. XPS peaks of Al, Ga, N, O, C, and Zn elements were deconvoluted using CasaXPS software, after applying Shirley background corrections.

Considering the elements constituting the top layer, AlGaIn, Al 2p scan was fitted by two subpeaks [Fig. 2(a)] which represent Al-N (subpeak 1: 73.69 ± 0.016 eV)³⁹ and Al-O (Al-OH) (subpeak 2: 74.45 ± 0.011 eV)^{39,40} bonds. Ga 2p scan was fitted by three subpeaks [Fig. 2(b)] which denote Ga-N (subpeak 3: 1117.34 ± 0.011 eV)⁴¹ bonds, Ga-O (N-Ga-OH) (subpeak 4: 1118.46 ± 0.02 eV)⁴² bonds, and the Auger peak of N element (subpeak 5: 1116.12 ± 0.038 eV).⁴³ N 1s scan was fitted by five subpeaks [Fig. 2(c)] depicting N-Al (subpeak 6: 396.87 ± 0.019 eV)³⁹ bonds, N-Ga (subpeak 8: 397.96 ± 0.02 eV)⁴² bonds, N element in N-tetraphenylporphyrin (subpeak 7: 397.37 ± 0.011 eV)⁴⁴ (constituent of MoL), and Auger peaks of Ga (subpeak 9: 395.87 ± 0.029 eV and subpeak 10: 394.62 ± 0.029 eV)⁴⁵ element. These curve fittings confirmed the presence of MoL of porphyrin based organic molecules on the sample surface. Furthermore, the MoL was not bonded to either Al, Ga, or N atoms, on the AlGaIn layer.

C 1s element existed in different species on Zn-TPPOH/AlGaIn/GaN, since carbon formed the backbone of the molecular chain. Among them, the following four bonds were prominent and shown in Fig. 2(d), C 1s in the molecular layer,⁴⁶ C-H bonds (CH_3),⁴⁷ C-N-H⁴⁶ bonds, and C-OH⁴⁶ bonds (phenol) designated by subpeaks 11 (284.66 ± 0.017 eV), 12 (285.16 ± 0.02 eV), 13 (285.66 ± 0.034 eV), and 14 (286.41 ± 0.03 eV), respectively. This confirmed the presence of MoL of hydroxy-phenyl-porphyrin (TPPOH) organic molecules on the surface of Zn-TPPOH/AlGaIn/GaN. The O 1s spectra were curve fitted by four subpeaks with binding energies: 530.12 ± 0.031 eV (subpeak 15), 531.12 ± 0.032 eV (subpeak 16), 531.87 ± 0.036 eV (subpeak 17), and 532.62 ± 0.034 eV (subpeak 18), as shown in Fig. 2(e). Subpeak 15 is assigned to O bonded to Al [N-Al-(OH)₂].³⁹ Subpeaks 16 and 18 are attributed to O-Ga (Ga-OH)⁴⁸ bonds and C-OH⁴⁶ bonds, respectively. Subpeak 17 is designated to the OH species (on AlGaIn) attached to the OH molecules (phenol) due to hydrogen bonds.⁴⁸ Thus, the MoL of Zn-TPPOH was bonded to the hydroxyl layer present on AlGaIn/GaN via the OH functionalization, as illustrated in Fig. 1(c). Lastly, the XPS spectra of TPPOH/AlGaIn/GaN revealed the presence of the Zn metal as shown in Fig. 2(f), which was absent in AlGaIn/GaN [Fig. 2(f), inset figure], thereby confirming the association of the Zn central metal ion in the TPPOH molecules.

From XPS investigation, it can be said that the organic molecules of phenol functionalized metallated-Tetra Phenyl Porphyrin (Zn-TPPOH) followed the concept of self-assembly to form a single layer of the hydrocarbon film, which is self-terminating in nature, on the surface of AlGaIn/GaN. The head group (phenol) was bonded with the sample

FIG. 2. Deconvoluted XPS peaks of (a) aluminum (Al 2p), (b) gallium (Ga 2p), (c) nitrogen (N 1s), (d) carbon (C 1s), and (e) oxygen (O 1s), elements at the Zn-TPPOH/AIGaN/GaN sample surface and (f) XPS peaks of zinc (Zn 2p), Zn present as the central metal atom in the Zn-TPPOH molecule and absent on bare AIGaN/GaN (inset figure).

surface followed by the organization of the backbone and the tail part (Zn-TPP), as illustrated in Figs. 1(b) and 1(c). However, it was not evident whether the molecules were aligned uniformly [as represented in Fig. 1(b)] or not, yet the formation of a single layer of organic molecules was further assessed using Variable angle spectroscopic ellipsometry (which has often been used to determine the thickness of molecular monolayers^{49–51}) and Cross-sectional Transmission Electron Microscopy (X-TEM).

2. Variable angle spectroscopic ellipsometry

Ellipsometric incidence data $\Psi(\lambda)$ were collected at different angles of incidence (50° , 55° , and 70°) from bare AIGaN/GaN samples and Zn-TPPOH/AIGaN/GaN samples and analyzed over the transparent region of the samples [where the extinction coefficient $k(\lambda)=0$, from 600 to 900 nm]. The experimental data were fitted using the Cauchy dispersion model which is based on the fact that when light of a particular wavelength is incident on a transparent substrate, it refracts, as there is a change of medium. This means that the light deviates from its original path. The amount of deviation is determined by the refractive index. It is also based on the fact that light with a longer wavelength deviates less from its original path, which implies a lesser refractive index, and light with a shorter wavelength deviates more from its path, which implies a higher refractive index. The variation of the refractive index (n) with wavelength (λ) is described by Cauchy's equation^{51,52} as

$$n(\lambda) = A + \frac{B}{\lambda^2} + \frac{C}{\lambda^4}. \quad (1)$$

Firstly, the data from AIGaN/GaN samples were fitted using a six-layer model consisting of (1) Sapphire substrate, (2)

layer 1 (AlN): 150 nm, (3) layer 2 (graded AIGaN): 1000 nm, (4) layer 3 (GaN): 650 nm, (5) layer 4 (AIGaN): 25 nm, and (6) layer 5: a few nanometer thin layer, considered to be the native oxide layer on the AIGaN surface. The plot representing the data fitting is presented in Fig. 3(a). For this fitting, the fitting parameters are tabulated in Table I (S. No. 1).

The thickness of the oxide layer was found to be 3 ± 0.121 nm. The incorporation of a seventh layer to the above model did not improve the quality of the fits. Next, the data from Zn-TPPOH/AIGaN/GaN samples were fitted using the model created for the bare sample. But curve-fitting by the exact same model did not give the best fitting. After different iterations, the data were fitted using a seven-layer model consisting of (1) the Sapphire substrate, (2) layer 1 (AlN): 150 nm, (3) layer 2 (graded AIGaN): 1000 nm, (4) layer 3 (GaN): 650 nm, and (5) layer 4 (AIGaN): 25 nm. Layer 5 (oxide layer) was set to vary around 1 nm with similar Cauchy constants as charted in Table I for the bare AIGaN/GaN sample (S. No. 1). The thickness of layer 5 was obtained as 0.9 ± 0.052 nm. Layer 6 was added and was set to vary around 1 nm with slightly different Cauchy constants. The fitting parameters used for this fitting are tabulated in Table I, S. No. 2. Thereby, the thickness of layer 6, which is regarded as the molecular layer, was approximately 0.9 ± 0.071 nm. The plot representing the data fitting for Zn-TPPOH/AIGaN/GaN samples is presented in Fig. 3(b).

3. Cross-sectional transmission electron microscopy (X-TEM)

The findings from Spectroscopic Ellipsometry were supported by X-TEM. X-TEM was performed at an acceleration

FIG. 3. Spectroscopic ellipsometry showing the variation of $\Psi(\lambda)$ with the wavelength in the transparent region for (a) AlGaIn/GaN samples and (b) Zn-TPPOH/AlGaIn/GaN samples collected at an incident angle of 50° and the curve fitting (solid line) using the Cauchy dispersion model; X-TEM images of (c) Au/Ni/semiconductor and (d) Au/Ni/MoL/semiconductor structures.

voltage of 300 kV using an FEI Titan ST microscope system. The X-TEM specimens were prepared by focus ion beam (FIB) using an FEI Helios SEM system with a Ga ion source. X-TEM images of Au/Ni/AlGaIn/GaN and Au/Ni/

MoL/AlGaIn/GaN samples are shown in Figs. 3(c) and 3(d), respectively. Figure 3(c) shows the presence of an amorphous interlayer between Ni and AlGaIn. The thickness of the layer was estimated as ~ 2.7 nm. This layer was regarded as the oxide layer⁵³ that is present at the metal/AlGaIn interface. X-TEM on Ni/Zn-TPPOH/AlGaIn/GaN samples showed the presence of another amorphous interlayer having a thickness of ~ 1.7 nm. This interlayer was related to the combination of the MoL and the oxide layer on AlGaIn.

TABLE I. Best-fit parameter values from the Cauchy model for AlGaIn/GaN and Zn-TPPOH/AlGaIn/GaN samples.

S. No.	Sample	Fitting parameters	Cauchy model
1.	AlGaIn/GaN	Mean squared error (MSE)	28.42
		Thickness (nm)	3 ± 0.1211
		A	2.28 ± 0.034
		B	0.16 ± 0.026
		C	Less influence on data fitting, so ~ 0
2.	Zn-TPPOH/AlGaIn/GaN	Mean squared error (MSE)	25.8
		Thickness (nm)	0.9 ± 0.071
		A	1.91 ± 0.057
		B	0.10 ± 0.012
		C	Less influence on data fitting, so ~ 0

B. Effect of molecular adsorption on the surface electrical properties of AlGaIn/GaN

1. XPS peak-shift analysis

After analyzing the presence, the nature of bonding and the quality of the MoL, the effect of adsorption of Zn-TPPOH organic molecules was observed on the surface electrical properties of AlGaIn/GaN. Core level XPS peaks of Al, Ga, and N surface elements for the Zn-TPPOH/AlGaIn/GaN sample was compared to the peak data collected from the bare AlGaIn/GaN sample surface to analyze the effect. The comparison is shown in Fig. 4, where the upper part of the images relates to deconvoluted XPS peaks for the bare

FIG. 4. Deconvoluted XPS peaks for (a) Al 2p, (b) Ga 2p, and (c) N 1s elements on AlGaIn/GaN (upper part-designated by H) and Zn-TPPOH/AlGaIn/GaN (lower part-designated by HP) sample surfaces.

AlGaIn/GaN sample, termed as H in the figure. The lower part of the plots represents the deconvoluted XPS core level peaks for the Zn-TPPOH-covered AlGaIn/GaN samples, termed as HP in the figure. It can be seen that there is a shift in the XPS peaks of all the elements toward higher binding energy when the surface of AlGaIn/GaN is modified by the MoL. XPS signals corresponding to emission from the substrate face an energy difference of approximately 250 meV. Subpeak 1H [Fig. 4(a)] representing Al-N bonds was shifted by ~ 270 meV, subpeak 3H [Fig. 4(b)] representing Ga-N bonds was shifted by ~ 250 meV, and subpeaks 6H and 8H [Fig. 4(c)] corresponding to N-Al and N-Ga bonds were shifted by ~ 260 meV and ~ 250 meV. The Auger peaks of Ga (subpeaks 9H and 10H) and N (subpeak 5H) elements were also shifted accordingly. The cause of these shifts cannot be attributed to chemical shifts because it has been explained above that the MoL was not bonded to either Al, Ga, or N elements on the sample surface. Because both the substrates were grounded, this difference in the electrostatic potential at the top of the surface of AlGaIn is attributed to the decrease in the surface potential (surface band-

bending)^{25,26} of MoL/AlGaIn/GaN samples by approximately 0.25 eV.

2. Kelvin probe force microscopy (KPFM)

Kelvin Probe Force Microscopy (KPFM) was employed as the secondary method to compare the change in the surface potential of AlGaIn/GaN due to the surface alteration by the MoL adsorption. KPFM was used considering the fact that the contact potential difference (CPD) (measured by KPFM) is related to the surface potential for a semiconductor surface (due to the space charge layer).^{12,54,55} KPFM was performed in air on both AlGaIn/GaN and MoL/AlGaIn/GaN samples. Prior to the measurements, the probe tip was calibrated with respect to freshly cleaved highly oriented pyrolytic graphite (HOPG), used as a reference material. The same tip was then used for measuring the contact potential difference at five different locations on both bare cleaned AlGaIn/GaN samples and MoL bonded AlGaIn/GaN samples at a scan size of $10 \times 10 \mu\text{m}^2$. The values of the potential were calculated by Nanoscope Analysis software, and the

FIG. 5. (a) Plot showing values of CPD (with error bars in the inset) for AlGaIn/GaN and Zn-TPPOH/AlGaIn/GaN samples; inset KPFM image of (i) AlGaIn/GaN and (ii) Zn-TPPOH/AlGaIn/GaN samples. The conduction energy band diagram for (b) bare AlGaIn/GaN, and (c) Zn-TPPOH/AlGaIn/GaN showing a decrease in the surface potential due to the adsorption of MoL.

KPFM images are shown in the inset of Fig. 5(a) (i and ii). The value of the CPD was found to be 690 ± 4 mV for bare cleaned the AlGaIn/GaN sample surface. It was observed that CPD decreased to 427 ± 3 mV when MoL of Zn-TPPOH organic molecules was chemisorbed on the sample surface, as plotted in Fig. 5(a). These measurements revealed that the adsorption of the organic molecular monolayer was responsible for the considerable reduction in the surface potential of AlGaIn/GaN by ~ 260 meV. It can also be seen that this value is similar to the values obtained from the shift in the XPS peak (toward higher binding energy) of the substrate elements Al, Ga, and N by ~ 0.25 eV, as presented above.

C. Effect of molecular surface passivation on electrical properties of device structures

1. Current-voltage (I-V) measurements

This part demonstrates the application of adsorption of organic molecules for improving the electrical characteristics of nickel Schottky diodes on AlGaIn/GaN. Current-Voltage (I-V) characteristics of two device structures were measured and compared, Ni/AlGaIn/GaN and Ni/Zn-TPPOH MoL/AlGaIn/GaN Schottky barrier diodes (SBDs). I-V was measured using tungsten (W) needles with a tip diameter of 50 μ m, connected to micromanipulators in EverBeing DC Probe station (EB 6) and the Keithley SCS-4200 semiconductor characterization system, in a voltage sweep mode. One probe was connected to the Ohmic contact, and the other was gently touched onto the Schottky diodes. The measurements

were taken on ten SBDs on each sample, at room temperature. A schematic representation of the electrical characterization is drawn in the inset of Fig. 6(b). I-V curves in the log scale, comparing the electrical characteristics of Ni SBDs on bare AlGaIn/GaN samples and Zn-TPPOH/AlGaIn/GaN samples in both forward and reverse bias, are shown in Fig. 6(a). A noteworthy decrement in the current during the reverse bias is manifested when the MoL of phenol functionalized organic molecules was inserted between the metal and the semiconductor. The current was reduced by up to ~ 4 orders of magnitude (from $2.6 \pm 1.93 \mu$ A to 0.31 ± 0.198 nA) at -5 V. For clarity, the error bar in reverse current [Fig. 6(a)] is presented for each curve at only one negative bias voltage. In the forward bias, the Schottky barrier height was calculated using the thermionic emission current equation. For thermionic emission (TE) and for $V > 3kT/q$, the general diode equation is given by⁵⁶

$$I_n = \left[AA^* T^2 \exp\left(-\frac{q\phi_{BnTE}}{kT}\right) \right] \left[\exp\left(\frac{qV}{\eta kT}\right) - 1 \right], \quad (2)$$

where A is the area of the Schottky diode, A^* is the effective Richardson coefficient, T is the absolute temperature, q is the fundamental electronic charge, ϕ_{BnTE} is the barrier height, k is Boltzmann's constant, V is the applied voltage, and η is the ideality factor. Taking the $\ln$ of Eq. (2), the Schottky

FIG. 6. (a) I-V characteristics comparing the electrical characteristics of Ni/AlGaIn/GaN (square icon) and Ni/Zn-TPPOH MoL/AlGaIn/GaN (circle icon) SBDs; (b) Plot showing the significant improvement in the calculated values of IF (blue colour) and SBH (red colour) for Ni/Zn-TPPOH/AlGaIn/GaN SBDs (circle shaped icons) as compared to Ni/AlGaIn/GaN SBDs (square shaped icons), measurement done on 10 SBDs on each sample; inset figure: A schematic illustration of electrical characterization of Ni SBDs on AlGaIn/GaN samples; Conduction energy band diagram for (c) metal/AlGaIn/GaN structures (d) reverse biased metal/AlGaIn/GaN (e) metal/MoL/AlGaIn/GaN structures, and (f) reverse biased metal/MoL/AlGaIn/GaN.

barrier height (SBH) was calculated using the relation

$$\phi_{bo} = \frac{kT}{q} \ln \left(\frac{AA^*T^2}{I_s} \right), \quad (3)$$

where I_s is the saturation current which is calculated from the y axis intercept of the $\ln I$ -V plot. SBH was calculated as 0.91 ± 0.05 eV for Ni SBDs on AlGaIn/GaN. It was seen that SBH was increased to 1.37 ± 0.03 eV for Ni SBDs on Zn-TPPOH MoL/AlGaIn/GaN samples [shown in Fig. 6(b)]. Ideality factor (IF) (η), which was calculated using the relation $\eta = \frac{q}{kT} \left(\frac{dV}{d(\ln I)} \right)$, was found to decrease from 2.5 ± 0.31 for Ni/AlGaIn/GaN SBDs to 1.4 ± 0.29 for Ni/Zn-TPPOH/AlGaIn/GaN SBDs [shown in Fig. 6(b)]. A noticeable improvement in the SBH was observed due to chemisorption of phenol functionalized TPP organic molecules on AlGaIn/GaN samples.

2. Capacitance-voltage (C-V) measurements

Capacitance-Voltage (C-V) profiling was done to get information about the effect of molecular surface passivation on the sheet carrier concentration of the 2-dimensional channel layer at the AlGaIn/GaN interface. C-V measurements were done using the same DC probe station and the semiconductor characterization system as was used for I-V measurements. One probe was connected to the Ohmic contact, and the other was gently touched onto the Schottky diodes, as illustrated in the inset of Fig. 6(b). The system was operated at room temperature in the voltage sweep mode at a frequency of 10 KHz. The experimentally obtained values of capacitance as a function of voltage for Ni/AlGaIn/GaN and Ni/Zn-TPPOH/AlGaIn/GaN Schottky structures are plotted in Fig. 7(a). It can be seen that there is a hump at around -4 V in the C-V curve of Ni/AlGaIn/GaN Schottky diodes. This is indicative of the presence of interface trap states due to the oxide interlayer (native oxide layer) at the metal-semiconductor interface.⁵⁷ Furthermore, the hump is reduced for Ni/Zn-TPPOH/AlGaIn/GaN Schottky structures. This reveals a decrease in the density of interface states at the metal/MoL/semiconductor interface. It can also be seen that there is a decrease in the capacitance in the region where the channel is fully open, when the surface of AlGaIn/GaN is coated with the MoL, as elaborated in the inset of Fig. 7(a). From C-V profiling, the carrier concentration can be

calculated using the mathematical expression,⁵⁸

$$N_{C-V} = \frac{C^3}{e\epsilon\epsilon_0} \frac{dV}{dC} \quad (4)$$

as a function of depth which is given by

$$z_{C-V} = \frac{\epsilon\epsilon_0}{C}, \quad (5)$$

where C is the measured differential capacitance per unit area, V is the voltage applied to the Schottky contact, ϵ is the dielectric constant of the material, ϵ_0 is the dielectric constant of air, and e is the electronic charge. The calculated $N_{C-V}(z_{C-V})$ profiles for AlGaIn/GaN and Zn-TPPOH/AlGaIn/GaN samples are shown in Fig. 7(b). It can be seen that firstly, the carrier concentration is the highest at the depth where the AlGaIn/GaN interface lies, indicating the formation of 2DEG for both the samples. Secondly, the carrier concentration of the 2DEG for the Zn-TPPOH/AlGaIn/GaN samples was reduced as compared to that obtained for bare AlGaIn/GaN samples. In order to find the values of the sheet carrier concentration in the channel, N_{C-V} was integrated with respect to z_{C-V} using the equation,⁵⁸

$$n_s = \int_{-\infty}^{\infty} N_{C-V}(z_{C-V}) dz_{C-V} = \int_{-\infty}^{\infty} n(z) dz. \quad (6)$$

The value of sheet concentration in the 2-dimensional channel layer was calculated as $1.09 \times 10^{13} \text{ cm}^{-2}$ for bare AlGaIn/GaN. n_s was decreased to $9.4 \times 10^{12} \text{ cm}^{-2}$ for Zn-TPPOH/AlGaIn/GaN samples. Thus, due to the adsorption of organic molecules on AlGaIn/GaN, the sheet carrier concentration was decreased, though slightly.

D. Discussion

AlGaIn/GaN HEMTs are specialized because of the presence of the 2-dimensional channel layer termed as the 2-dimensional electron gas (2DEG) which allows the carriers to flow with higher mobility. For n-doped AlGaIn or GaN layers, the 2DEG is formed by the concept of modulation doping.⁵⁹ On the other hand, for undoped epilayers, the mechanism is different. In some reports, it is demonstrated that 2DEG for undoped AlGaIn layers is formed due to the effect of polarization in III-Nitride semiconducting materials.⁵⁸ In other reports, the experimentally observed higher electron density in 2DEG has been explained by demonstrating the existence of donor-like states on the surface of

FIG. 7. (a) C-V characteristics for Ni/AlGaIn/GaN and Ni/Zn-TPPOH/AlGaIn/GaN Schottky structures at a frequency of 10 KHz (b) C-V concentration profile N_{C-V} Vs penetration depth for AlGaIn/GaN and Zn-TPPOH/AlGaIn/GaN structures.

FIG. 8. Schematic illustration for distribution of charge carriers for (a) bare AlGaIn/GaN, (b) metal/AlGaIn/GaN, (c) MoL/AlGaIn/GaN, and (d) metal/MoL/AlGaIn/GaN structures.

AlGaIn¹⁰ (originating from either native oxide layer or structural defects or unsatisfied bonds on the surface).⁶⁰ It may be noted that surface states are termed as donor-like in the sense that they are neutral when occupied by electron and positively charged when they are empty. It has been shown that for a certain critical thickness of the AlGaIn layer, the electrons are transferred from the occupied surface states to the empty conduction band states at the interface, thereby creating the 2DEG.¹⁰ However, despite the benefits of these mechanisms (in forming the 2DEG for undoped epilayers), there are certain issues that hinder a good device performance. One of the major issues is the formation of positive surface charge due to both the mechanisms.^{10,18} The surface charge leads to band-bending at the surface of the semiconductor, the extent of which is described by the surface potential⁶¹ (~ 690 meV for our case). The presence of the surface potential and the formation of 2DEG are illustrated in the form energy band diagram in Fig. 5(b) and in the form of schematic illustration in Fig. 8(a).⁶²

When the Schottky metal is deposited on the AlGaIn/GaN heterostructure, the parasitic charge on the surface of the semiconductor forms an image charge on the surface of metal leading to the formation of interface dipoles, as illustrated in Fig. 8(b).²⁰ This further leads to the formation of interface potential V_i , as illustrated in Fig. 6(c). This interface potential adversely affects the Schottky barrier (ϕ_{Bn}) formed at the metal-semiconductor interface, according to the equation²⁰

$$\phi_{Bn} = \phi_m - \chi_s - V_i, \quad (7)$$

where ϕ_m is the work function of the metal and χ_s is the

electron affinity of the semiconductor. It can be seen from Eq. (7) that as V_i increases, ϕ_{Bn} decreases ($\phi_{Bn-Ni/AlGaIn/GaN} \sim 0.91$ eV). When such a metal-semiconductor structure is given a reverse bias, then as the carriers move from the metal to the semiconductor, firstly, they find a free trap state pathway (due to surface states), which allows tunneling of the carriers. Secondly, they also face a lower potential barrier at the interface and tend to jump over the barrier to reach the semiconductor side, as shown in Fig. 6(d), thereby leading to a higher reverse bias leakage current (in $\sim \mu A$ range for our case).

In this work, the solution to the issues due to surface states is sought by the adsorption of a single layer of organic molecules. From experimental observations, it is evident that by the adsorption of the molecular layer (MoL), the surface potential on AlGaIn/GaN is reduced, as illustrated in the form of the energy band diagram in Fig. 5(c). Shifting of XPS peaks of substrate elements toward higher binding energies and KPFM images revealed a decrease in the surface potential of molecular-coated AlGaIn/GaN by ~ 250 meV. The decrease in the surface potential is indicative of the decrease in the surface charge which is attributed to different reasons. Firstly, the organic molecular adsorption process has led to a decrease in the density of surface states, as illustrated in Fig. 8(c). This is because the thinner oxide layer was detected in X-TEM images of Zn-TPPOH/AlGaIn/GaN samples and the hump at -4 V in the C-V measurements was reduced for Ni/Zn-TPPOH/AlGaIn/GaN structures. Secondly, there is some molecule-semiconductor interaction (interaction between the electric field generated by the dipoles of organic molecules and the surface charge^{63,64} or some induction of charges⁶⁵) due to which the 2DEG electrons are extracted to the void surface donor-like surface states, thereby reducing the surface charge (by making them neutral), as represented in Fig. 8(c). This can be said because the carrier concentration of the 2DEG was found to be reduced for MoL/AlGaIn/GaN samples. However, at this point, we are unable to explain the exact mechanism at the molecule-semiconductor interface.

When the metal comes in contact with the MoL/AlGaIn/GaN surface, lesser surface charge is left between the metal and the MoL/AlGaIn/GaN surface, as illustrated in Fig. 8(d), leading to a decrease in the interface potential V_i , as shown in Fig. 6(e). As a consequence, the Schottky barrier height is increased ($\phi_{Bn-Ni/Zn-TPPOH/AlGaIn/GaN} \sim 1.37$ eV), according to Eq. (7). When the metal/MoL/semiconductor structure is given reverse bias, then the carriers moving from the metal to the semiconductor face a blocked trap state pathway, thereby reducing tunneling at the metal-semiconductor interface. As the carriers tend to jump over the barrier to reach the semiconductor side, they face an increased potential barrier, as presented in Fig. 6(f). Accordingly, the experimentally observed reverse bias leakage current for Ni/Zn-TPPOH/AlGaIn/GaN structures was reduced by $\sim 3-4$ orders of magnitude to nA range. Conclusively, the passivation of surface states has led to enhancement in the device performance (lower reverse current implies better functioning of the gate electrode and a higher device breakdown voltage).

IV. CONCLUSIONS

In summary, organic molecules of phenol functionalized metallated-Tetra Phenyl Porphyrin were adsorbed on AlGaIn/GaN HEMT heterostructures. The organic molecules followed the concept of self-assembly, as assessed from XPS, to form a monolayer on AlGaIn/GaN, as estimated from Ellipsometry and X-TEM. The effect of molecular surface assimilation was seen in the form of a decrease in the surface potential on AlGaIn/GaN by ~ 250 meV, as revealed by XPS peak-shift analyses and KPFM. Consequently, the electrical characteristics of rectifying metal-semiconductor contacts on Zn-TPPOH/AlGaIn/GaN were significantly enhanced. This was because the molecular layer was passivating the donor-like surface states on AlGaIn/GaN by either extracting the charge carriers from the 2DEG, as evident from capacitance-voltage measurements, or by reducing the density of surface states (oxide layer-related states), as evident from X-TEM. These analyses signify that the implementation of the innovative concept of organic molecular layer insertion (at the metal-semiconductor interface) opens up a viable and inexpensive pathway for enhancing the device performance and reliability of AlGaIn/GaN based high electron mobility transistors, mitigating the adverse effects of surface states and polarization in these materials.

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¹T. Mimura, *IEEE Trans. Microw. Theory Tech.* **50**, 780 (2002).

²O. Hammi and F. M. Ghannouchi, in *Proceedings of the 16th IEEE International Conference on Electronics, Circuits and Systems (ICECS)* (IEEE, Yasmine Hammamet, 2009), p. 379.

³T. Oka and T. Nozawa, *IEEE Electron Device Lett.* **29**, 668 (2008).

⁴X.-D. Wang, W.-D. Hu, X.-S. Chen, and W. Lu, *IEEE Trans. Electron Devices* **59**, 1393 (2012).

⁵P. Lagger, M. Reiner, D. Pogany, and C. Ostermaier, *IEEE Trans. Electron Devices* **61**, 1022 (2014).

⁶Y. Tang, K. Shinohara, D. Regan, A. Corrión, D. Brown, J. Wong, A. Schmitz, H. Fung, S. Kim, and M. Micovic, *IEEE Electron Device Lett.* **36**, 549 (2015).

⁷M. A. Khan, A. Bhattarai, J. N. Kuznia, and D. T. Olson, *Appl. Phys. Lett.* **63**, 1214 (1993).

⁸O. Ambacher, B. Foutz, J. Smart, J. R. Shealy, N. G. Weimann, K. Chu, M. Murphy, A. J. Sierakowski, W. J. Schaff, and L. F. Eastman, *J. Appl. Phys.* **87**, 334 (2000).

⁹U. K. Mishra, P. Parikh, and Y.-F. Wu, *Proc. IEEE* **90**, 1022 (2002).

- ¹⁰J. P. Ibbetson, P. T. Fini, K. D. Ness, S. P. Denbaars, J. S. Speck, and U. K. Mishra, *Appl. Phys. Lett.* **77**, 250 (2000).
- ¹¹F. Qian, D. Kai, L. Y. Kun, S. Peng, and F. Qing, *Chin. Phys. Lett.* **30**, 127302 (2013).
- ¹²A. Kumar, R. Kapoor, M. Garg, V. Kumar, and R. Singh, *Nanotechnology* **28**, 26LT02 (2017).
- ¹³R. Veturly, N. Q. Zhang, S. Keller, and U. K. Mishra, *IEEE Trans. Electron Devices* **48**, 560 (2001).
- ¹⁴M. Gassoumi, B. Grimbert, C. Gaquiere, and H. Maaref, *Semiconductors* **46**, 382 (2012).
- ¹⁵T. Hashizume, S. Ootomo, and H. Hasegawa, *Appl. Phys. Lett.* **83**, 2952 (2003).
- ¹⁶Y. Hori, Z. Yatabe, and T. Hashizume, *J. Appl. Phys.* **114**, 244503 (2013).
- ¹⁷M. Matys, S. Kaneki, K. Nishiguchi, B. Adamowicz, and T. Hashizume, *J. Appl. Phys.* **122**, 224504 (2017).
- ¹⁸S. Heikman, S. Keller, Y. Wu, J. S. Speck, S. P. DenBaars, and U. K. Mishra, *J. Appl. Phys.* **93**, 10114 (2003).
- ¹⁹B. S. Eller, J. Yang, and R. J. Nemanich, *J. Electron. Mater.* **43**, 4560 (2014).
- ²⁰R. T. Tung, *Phys. Rev. B* **64**, 205310 (2001).
- ²¹A. Rizzi, M. Kocan, J. Malindretos, A. Schildknecht, N. Teofilov, K. Thonke, and R. Sauer, *Appl. Phys. A* **87**, 505 (2007).
- ²²B. K. Li, M. J. Wang, K. J. Chen, and J. N. Wang, *Phys. Status Solidi C* **7**, 1961 (2010).
- ²³F. Schreiber, *Prog. Surf. Sci.* **65**, 151 (2000).
- ²⁴M. Jurow, A. E. Schuckman, J. D. Batteas, and C. M. Drain, *Coord. Chem. Rev.* **254**, 2297 (2010).
- ²⁵T. Aqua, H. Cohen, O. Sinai, V. Frydman, T. Bendikov, D. Krepel, O. Hod, L. Kronik, and R. Naaman, *J. Phys. Chem. C* **115**, 24888 (2011).
- ²⁶T. Schultz, R. Schlesinger, J. Niederhausen, F. Henneberger, S. Sadofev, S. Blumstengel, A. Vollmer, F. Bussolotti, J.-P. Yang, S. Kera, K. Parvez, N. Ueno, K. Mullen, and N. Koch, *Phys. Rev. B* **93**, 125309 (2016).
- ²⁷S. Bastide, R. Butruille, D. Cahen, A. Dutta, J. Libman, A. Shanzer, L. Sun, and A. Vilan, *J. Phys. Chem. B* **101**, 2678 (1997).
- ²⁸I. Borriello, G. Cantele, D. Ninno, G. Iadonisi, M. Cossi, and V. Barone, *Phys. Rev. B* **76**, 035430 (2007).
- ²⁹R. Cohen, N. Zenou, D. Cahen, and S. Yitzchaik, *Chem. Phys. Lett.* **279**, 270 (1997).
- ³⁰A. Vilan, A. Shanzer, and D. Cahen, *Nature* **404**, 166 (2000).
- ³¹Y. Selzer and D. Cahen, *Adv. Mater.* **13**, 508 (2001).
- ³²H. Haick, M. Ambrico, T. Ligonzo, and D. Cahen, *Adv. Mater.* **16**, 2145 (2004).
- ³³M. Garg, T. R. Naik, C. S. Pathak, V. R. Rao, and R. Singh, *Appl. Phys. Lett.* **112**, 163502 (2018).
- ³⁴M. A. Khaderbad, R. Pandharipande, V. Singh, S. Madhu, M. Ravikanth, and V. R. Rao, *IEEE Trans. Electron Devices* **59**, 1963 (2012).
- ³⁵M. A. Khaderbad, V. Tjoa, M. Rao, R. Phandripande, S. Madhu, J. Wei, M. Ravikanth, N. Mathews, S. G. Mhaisalkar, and V. R. Rao, *ACS Appl. Mater. Interfaces* **4**, 1434 (2012).
- ³⁶B. Baur, J. Howgate, H.-G. von Ribbeck, Y. Gawlina, V. Bandalo, G. Steinhoff, M. Stutzmann, and M. Eickhoff, *Appl. Phys. Lett.* **89**, 183901 (2006).
- ³⁷B. S. Kang, H. T. Wang, F. Ren, and S. J. Pearton, *J. Appl. Phys.* **104**, 031101 (2008).
- ³⁸M. A. Khaderbad, U. Roy, M. Yedukondalu, M. Rajesh, M. Ravikanth, and V. R. Rao, *IEEE Trans. Nanotechnol.* **9**, 335 (2010).
- ³⁹L. Rosenberger, R. Baird, E. McCullen, G. Aunerc, and G. Shreve, *Surf. Interface Anal.* **40**, 1254 (2008).
- ⁴⁰J. A. Rotole and P. M. A. Sherwood, *Surf. Sci. Spectra* **5**, 32 (1998).
- ⁴¹Y.-J. Lin, H.-Y. Lee, F.-T. Hwang, and C.-T. Lee, *J. Electron. Mater.* **30**, 532 (2001).
- ⁴²X. Zhang and S. Ptasińska, *Sci. Rep.* **6**, 24848 (2016).
- ⁴³V. Matolin, S. Fabík, J. Glosík, L. Bideux, Y. Ould-Metidji, and B. Gruzza, *Vacuum* **76**, 471 (2004).
- ⁴⁴D. K. Lavalley, J. Brace, and N. Winograd, *Inorg. Chem.* **18**, 1776 (1979).
- ⁴⁵G. Moldovan, I. Harrison, M. Roe, and P. D. Brown, in Presented at The Electron microscopy and analysis 2003: Proceedings of the Institute of Physics Electron Microscopy and Analysis Group Conference (University of Oxford, 2003), September, p. 115.
- ⁴⁶S. J. Kerber, J. J. Bruckner, K. Wozniak, S. Seal, S. Hardcastle, and T. L. Barr, *J. Vac. Sci. Technol. A* **14**, 1314 (1996).
- ⁴⁷L. Chen, Z. Xu, J. Li, Y. Li, M. Shan, C. Wang, Z. Wang, Q. Guo, L. Liu, G. Chen, and X. Qian, *J. Mater. Chem.* **22**, 13460 (2012).
- ⁴⁸X. Zhang and S. Ptasińska, *Phys. Chem. Chem. Phys.* **17**, 3909 (2015).

- ⁴⁹A. Vilan, J. Ghabboun, and D. Cahen, *J. Phys. Chem. B* **107**, 6360 (2003).
- ⁵⁰T. Ishizaki, N. Saito, L. SunHyung, K. Ishida, and O. Takai, *Langmuir* **22**, 9962 (2006).
- ⁵¹P. K. B. Palomaki, A. Krawicz, and P. H. Dinolfo, *Langmuir* **27**, 4613 (2011).
- ⁵²R. M. A. Azzam, and N. M. Bashara, (North-Holland Publishing Co, New York, 1977).
- ⁵³A. Kumar, S. Vinayak, and R. Singh, *Curr. Appl. Phys.* **13**, 1137 (2013).
- ⁵⁴W. Melitz, J. Shen, A. C. Kummel, and S. Lee, *Surf. Sci. Rep.* **66**, 1 (2011).
- ⁵⁵S. Hudlet, M. S. Jean, B. Roulet, J. Berger, and C. Guthmann, *J. Appl. Phys.* **77**, 3308 (1995).
- ⁵⁶E. H. Rhoderick, *IEEE Proc. I Solid State Electron Devices* **129**, 1 (1982).
- ⁵⁷X. Wang, H. Liu, C. Fei, L. Zhao, S. Chen, and S. Wang, *AIP Adv.* **6**, 065224 (2016).
- ⁵⁸O. Ambacher, J. Smart, J. R. Shealy, N. G. Weimann, K. Chu, M. Murphy, W. J. Schaff, L. F. Eastman, R. Dimitrov, L. Wittmer, M. Stutzmann, W. Rieger, and J. Hilsenbeck, *J. Appl. Phys.* **85**, 3222 (1999).
- ⁵⁹H. X. Guang, Z. D. Gang, and J. D. Sheng, *Chin. Phys. B* **24**, 067301 (2015).
- ⁶⁰A. Kumar, T. Singh, M. Kumar, and R. Singh, *Curr. Appl. Phys.* **14**, 491 (2014).
- ⁶¹L. E. Black, "New Perspectives on Surface Passivation: Understanding the Si-Al₂O₃ Interface" (Springer International Publishing, Cham, 2016), p. 15.
- ⁶²Z. Lin and W. Lu, *J. Appl. Phys.* **99**, 014504 (2006).
- ⁶³A. Natan, L. Kronik, H. Haick, and R. T. Tung, *Adv. Mater.* **19**, 4103 (2007).
- ⁶⁴G. Ashkenasy, D. Cahen, R. Cohen, A. Shanzer, and A. Vilan, *Acc. Chem. Res.* **35**, 121 (2002).
- ⁶⁵L. Shen, X. Cheng, Z. Wang, C. Xia, D. Cao, L. Cheng, Q. Wang, and Y. Yu, *RSC Adv.* **5**, 86593 (2015).